

Supporting information

Solution processed Li_5AlO_4 dielectric for low voltage transistor fabrication and its application for metal oxide/quantum dot heterojunction phototransistor

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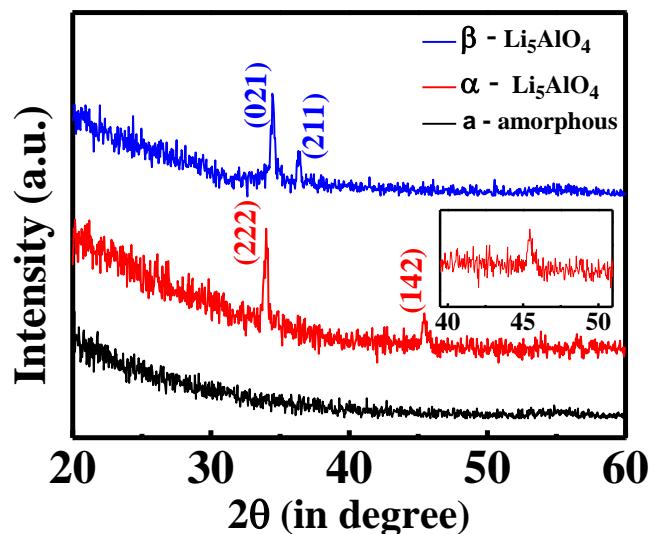


Fig. 1S. Grazing incidence X-ray diffraction (GIXRD) analysis of Li_5AlO_4 dielectric thin film

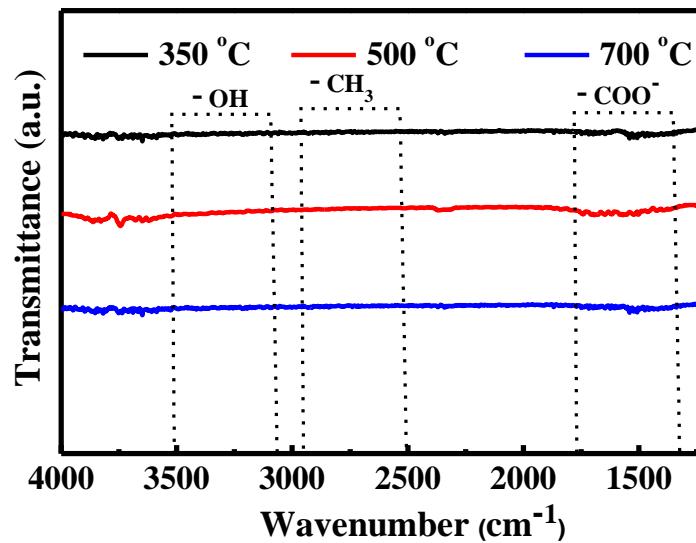


Fig. 2S. FTIR analysis of Li_5AlO_4 dielectric thin film anneal at 350 °C, 500 °C and 700 °C

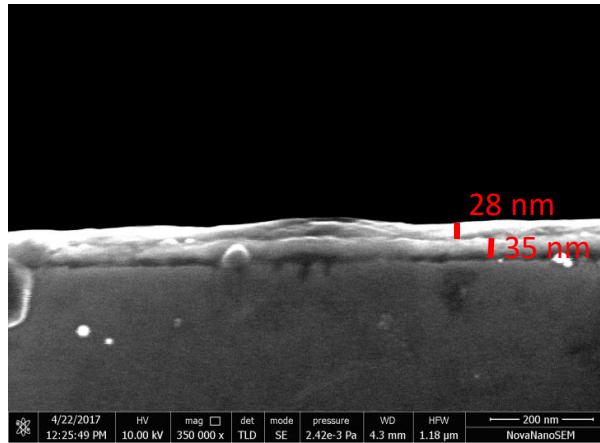


Fig. 3S: Cross-sectional scanning electron microgram of p++-Si/ α - Li_5AlO_4 / IZO film

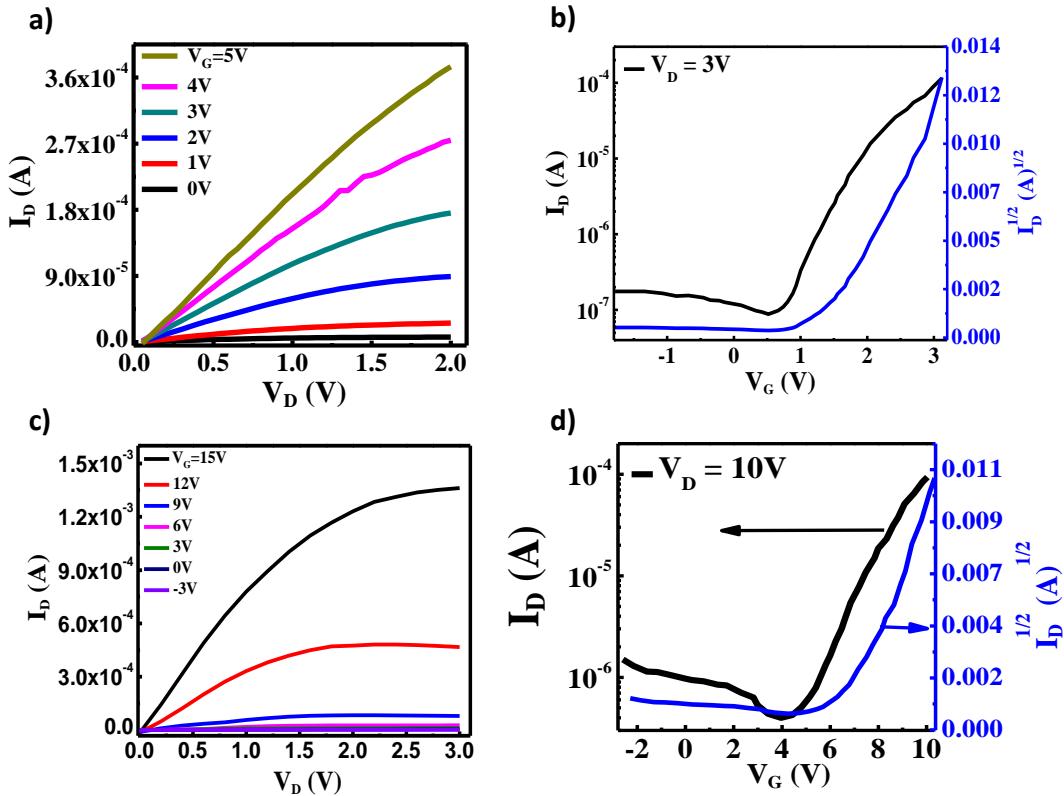


Fig. 4S The output characteristics for TFT fabricated with a) $\beta\text{-Li}_5\text{AlO}_4$ c) $\alpha\text{-Li}_5\text{AlO}_4$ dielectric. Transfer characteristics for TFT fabricated with b) $\beta\text{-Li}_5\text{AlO}_4$ d) $\alpha\text{-Li}_5\text{AlO}_4$ dielectric.

Table 1S: Comparison with recently published other high – k dielectric TFT

Dielectric Materials	Semicondutor	Fabrication Route	Capacitance (C) nFcm ⁻²	Mobility (μ) cm ² V ⁻¹ Sec ⁻¹	Product of capacitance and mobility ($\mu.C$) nF V ⁻¹ Sec ⁻¹	Novelty	Reference
$\alpha\text{-Li}_5\text{AlO}_4$	IZO	Solution - Processed	332	21.4	7304	New TFT gate dielectric. High capacitance and mobility ($\mu.C$) which result high current density TFT	This work
HfLaO _x	ZnO	Solution - Processed	190.09	1.6	330.15	Solution processed TFT gate dielectric	1
LiO _x	In ₂ O ₃	Solution - Processed	465	5.7	2650	New sol-gel derived TFT gate dielectric	2
Strontium titanate	Pentacene, CuPc	RF magnetron sputtering	41	2.0	2.46	Flexible device	3
Strontium oxide (SrO _x)	In ₂ O ₃	Solution - Processed	350	5.6	1963	Solution processed TFT gate dielectric	4
Magnesium titanium oxide (Mg _{0.6} Ti _{0.4} O)	IZO	Solution - Processed	50	3.4	170	New sol-gel derived TFT gate dielectric	5

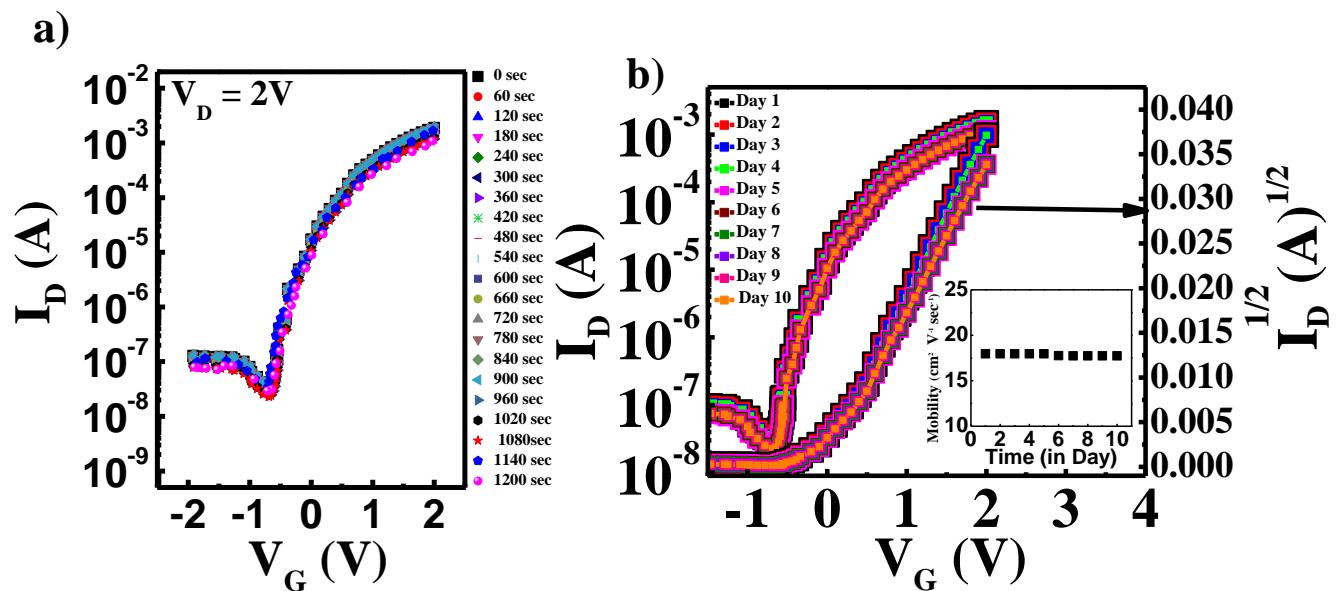


Fig. 5S Stability test of $\alpha\text{-Li}_5\text{AlO}_4$ dielectric TFT a) bias stress stability b) ambient atmosphere storage stability

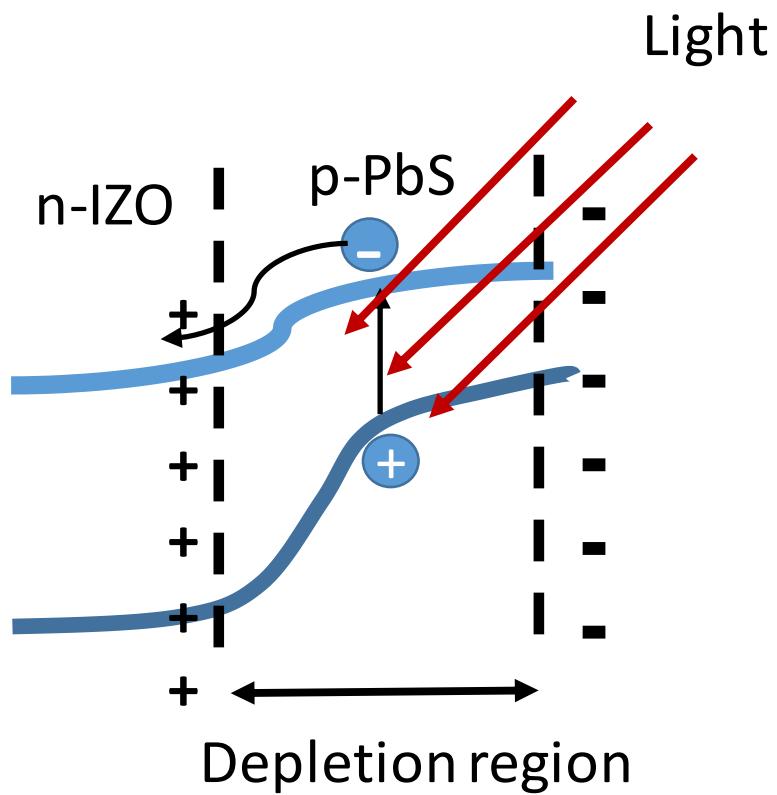


Fig. 6S Depletion layer formation of p-PbS/n-IZO heterojunction and photogenerated e-h separation due to the effect of barrier potential.

References:

1. J. Ko, J. Kim, S. Y. Park, E. Lee, K. Kim, K.-H. Lim and Y. S. Kim, *Journal of Materials Chemistry C*, 2014, **2**, 1050-1056.
2. A. Liu, G. Liu, C. Zhu, H. Zhu, E. Fortunato, R. Martins and F. Shan, *Adv. Electron. Mater.*, 2016, **2**, n/a-n/a.
3. S. Yadav and S. Ghosh, *ACS Applied Materials & Interfaces*, 2016, **8**, 10436-10442.
4. C. Fan, A. Liu, Y. Meng, Z. Guo, G. Liu and F. Shan, *IEEE Transactions on Electron Devices*, 2017, **PP**, 1-7.
5. Z. Yang, H. Pu, C. Cui, L. Zhang, C. Dong and Q. Zhang, *IEEE Electron Device Letters*, 2014, **35**, 557-559.